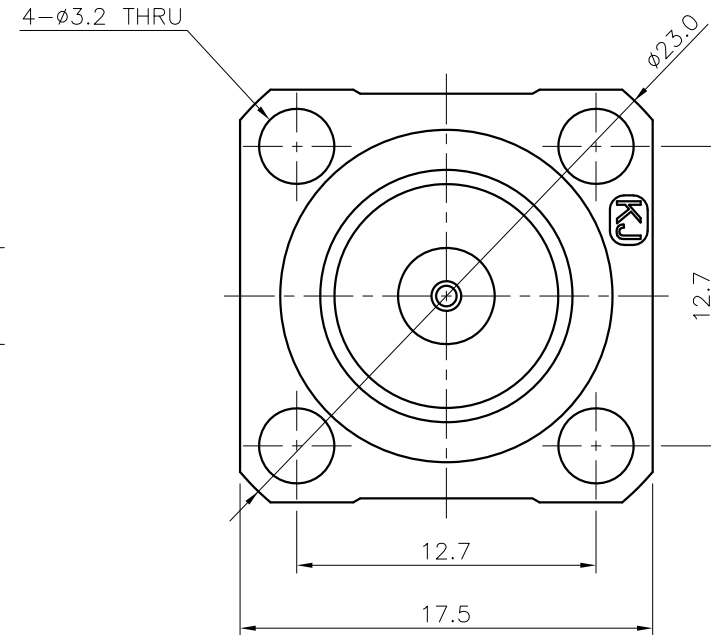
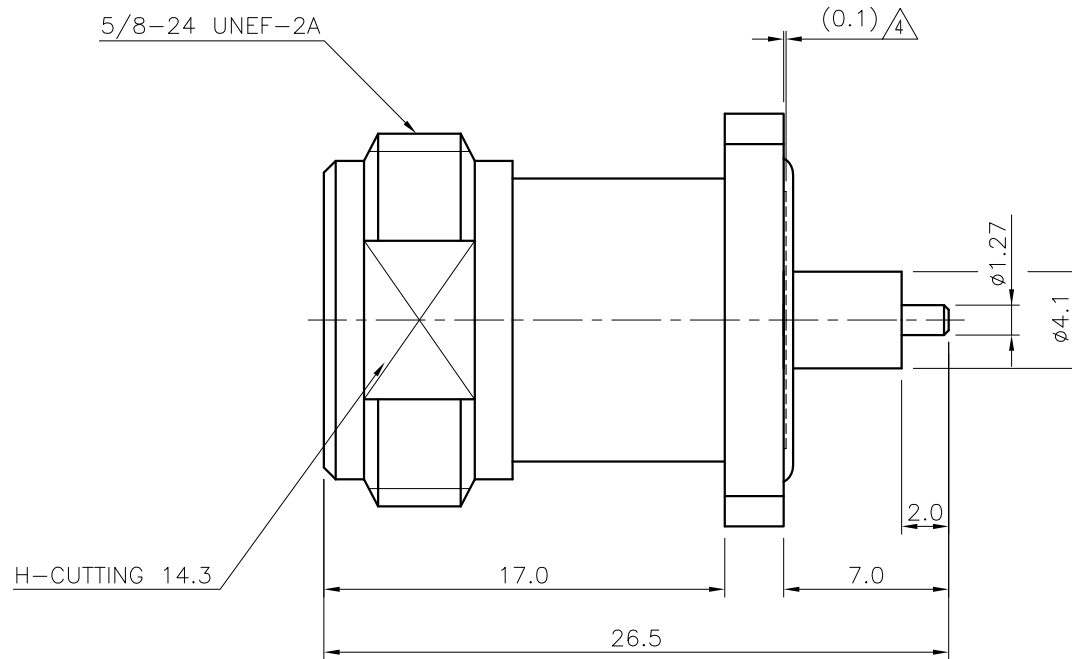


REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
IR	Initial Registration	I.C.KIM	J.H.YOUN	2012.02.06.	
1	[설변No.201401-0007] 신뢰성 향상(가스켓 변경)	M.H.SONG	I.C.KIM	2014.01.16.	
2	[설변No.201907-0003] NBR -> SILICONE 재질 변경	S.Y.EUN	I.C.KIM	2019.07.02.	
3	[설변No.202012-0002] O-RING 빠짐 개선 안착부 금형수정	I.C.KIM		2020.12.07.	
4	[설변No.202101-0003] O-RING 빠짐 개선 안착부 0.1mm Ground Boss 추가	S.Y.EUN	I.C.KIM	2021.01.20.	
5	[설변No.202305-0003] 조립시 절연체 늘어남에 따라 절연체 길이0.1mm줄임	S.H.KIM		2023.05.12.	



5	RING	1	MBsBD C3604BD-F	Nickel Plate	DSR01097-5/3 DSR01097-5/2 DSR01097-5/1
4	INSULATOR	1	TEFLON		DIN01965-N/2 DIN01965-N/1
3	GASKET	1	SILICONE Rub NBR SILICONE Rub		DGK00257-N/2 DGK00257-N/1 DGK00032-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT02524-5/1
1	BODY	1	ZnDC	Nickel Plate (3~4μm)	DBD02992-5/3 DBD02992-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2023. 05. 12.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle ±1°	APPROVED BY		TITLE N50 SOLDER END JS-4H			
	CHECKED BY						
MATERIAL _____	DRAWN BY		S.H.KIM		A4	DWG NO. CN03958-7/1	
FINISH _____	SCALE 3/1	UNIT mm				REVISION 5	SHEET 1 of 1